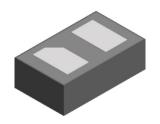


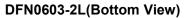
PESDRC2XD5VBLF

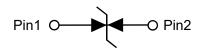
Bi-directional 5V Low Capacitance ESD Protector

Description

The PESDRC2XD5VBLF protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. They feature large cross-sectional area junctions for conducting high transient currents, offer desirable electrical characteristics for board level protection, such as fast response time, low operating voltage. It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.







Circuit Diagram



- > 40W peak pulse power per line ($t_P = 8/20\mu s$)
- Low clamping voltage
- DFN0603-2L package
- Response time is typically < 1 ns</p>
- Bidirectional configurations
- RoHS compliant
- Transient protection for data lines to IEC 61000-4-2(ESD) ±18kV(air), ± 18kV(contact); IEC 61000-4-5 (Lightning) 5.0A (8/20us)



Applications

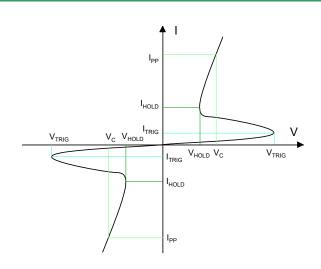
- Cellular phones
- Portable devices
- Digital cameras
- Power supplies
- ➢ USB 2.0 and USB 3.0
- HDMI 1.3 and HDMI 1.4

Mechanical Characteristics

- Mounting position: Any
- Qualified max reflow temperature:260°C
- Device meets MSL 1 requirements

Electronics Parameter

Symbol	Parameter			
V _{RWM}	Peak Reverse Working Voltage			
I _R	Reverse Leakage Current @ V _{RWM}			
V _{BR}	Breakdown Voltage @ I _T			
Ι _Τ	Test Current			
I _{PP}	Maximum Reverse Peak Pulse Current			
V _c	Clamping Voltage @ I _{PP}			
I _{TRIG}	Reverse Trigger Current			
V _{TRIG}	Reverse Trigger Voltage			
I _{HOLD}	Reverse Holding Current			
V _{HOLD}	Reverse Holding Voltage			



Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Peak Reverse Working Voltage	V _{RWM}	-	-	-	5.0	V
Breakdown Voltage	V _{BR}	I _t = 1mA	5.6	-	9.0	V
Reverse Leakage Current	I _R	V _{RWM} = 5V	-	-	1.0	μA
Clamping Voltage	V _c	I _{PP} = 5A,t _P = 8/20μs	-	6.0	8.0	V
Junction Capacitance	CJ	V _R = 0V,f = 1MHz	-	0.29	0.4	pF

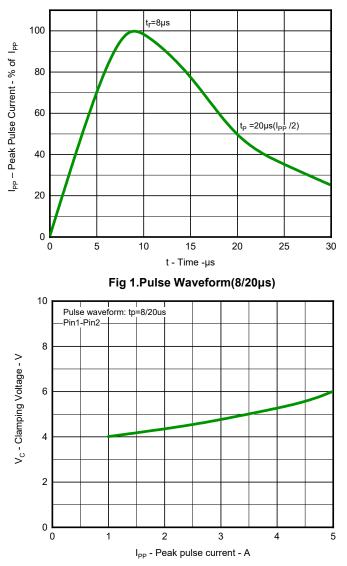
Absolute maximum rating@25°C

Rating	Symbol	Value	Units
Peak Pulse Power (t _P = 8/20µs)	P _{PP}	40	W
Peak Pulse Current (t _P = 8/20µs)	I _{PP}	5.0	А
Lead Soldering Temperature	Τ _L	260 (10 sec)	°C
Junction and Storage Temperature Range	T _{J,} T _{STG}	-55~+150	°C
ESD Protection-Contact Discharge	V _{ESD}	±18	kV
ESD Protection-Air Discharge	V _{ESD}	±18	kV

PESDRC2XD5VBLF

PESDRC2XD5VBLF

Typical Characteristics





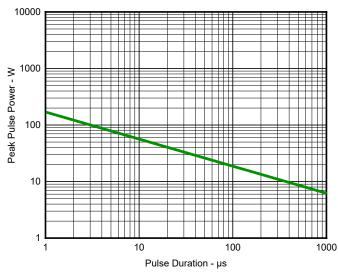
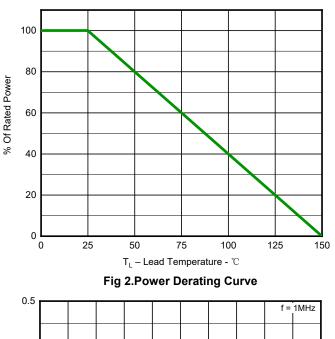


Fig 5. Non Repetitive Peak Pulse Power vs. Pulse time



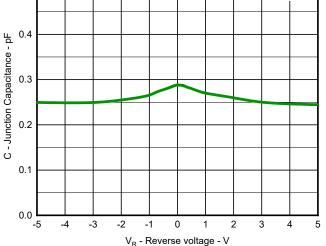


Fig 4. Capacitance vs. Reveres voltage

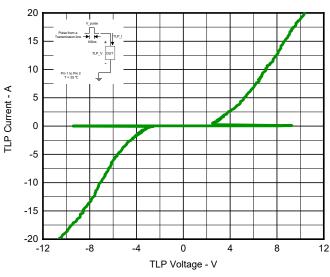
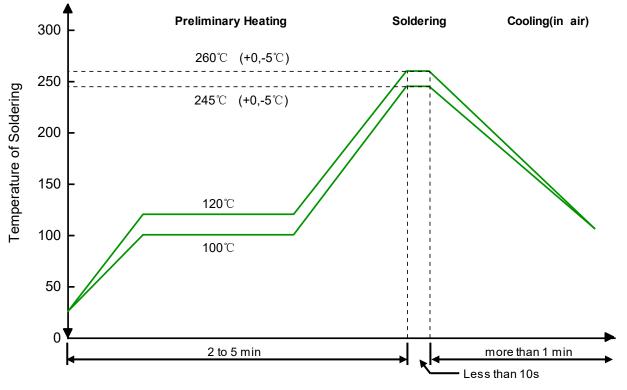


Fig 6. TLP Measurement

PESDRC2XD5VBLF

Solder Reflow Recommendation



Remark: Pb free for 260°C; Pb for 245°C.

PCB Design

For TVS diodes a low-ohmic and low-inductive path to chassis earth is absolutely mandatory in order to achieve good ESD protection. Novices in the area of ESD protection should take following suggestions to heart:

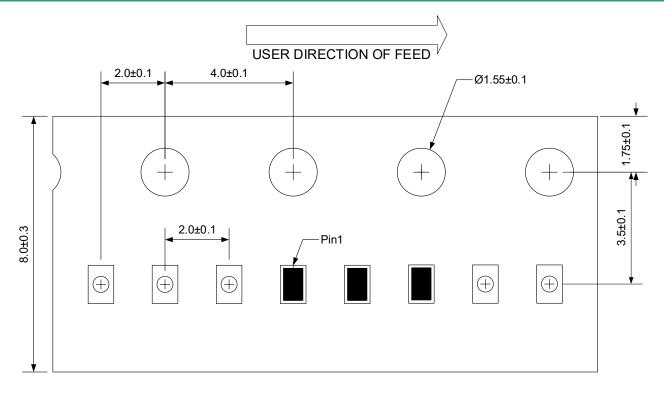
- > Do not use stubs, but place the cathode of the TVS diode directly on the signal trace.
- > Do not make false economies and save copper for the ground connection.
- > Place via holes to ground as close as possible to the anode of the TVS diode.
- Use as many via holes as possible for the ground connection.
- > Keep the length of via holes in mind! The longer the more inductance they will have.

Ordering information

Device	Package	Reel	Shipping
PESDRC2XD5VBLF	DFN0603-2L (Pb-Free)	7"	12000 / Tape & Reel

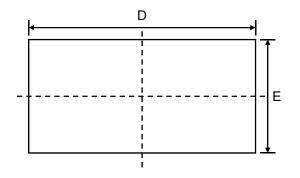
PESDRC2XD5VBLF

Load with information

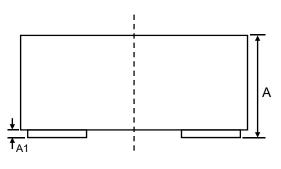


PESDRC2XD5VBLF

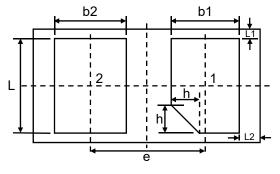
Product dimension (DFN0603-2L)



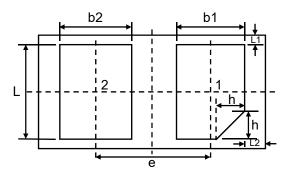




Side View

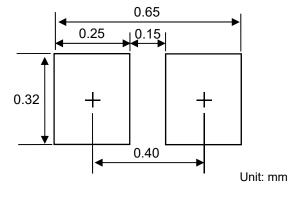


Bottom View



Bottom View

Dim	Millim	neters	Inches		
	Min	Мах	Min	Мах	
A	0.28	0.35	0.011	0.014	
A1	0.00	0.05	0.000	0.002	
b1	0.13	0.23	0.005	0.009	
b2	0.14	0.24	0.006	0.009	
D	0.55	0.65	0.022	0.026	
е	0.35 BSC		0.014 BSC		
L1	0.025 BSC		0.001 BSC		
L2	0.035 BSC		0.001 BSC		
E	0.25	0.35	0.010	0.014	
L	0.20	0.30	0.008	0.012	
h	0.00	0.10	0.000	0.004	



Suggested PCB Layout

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